

4229798/B 11/2023

NOTES:

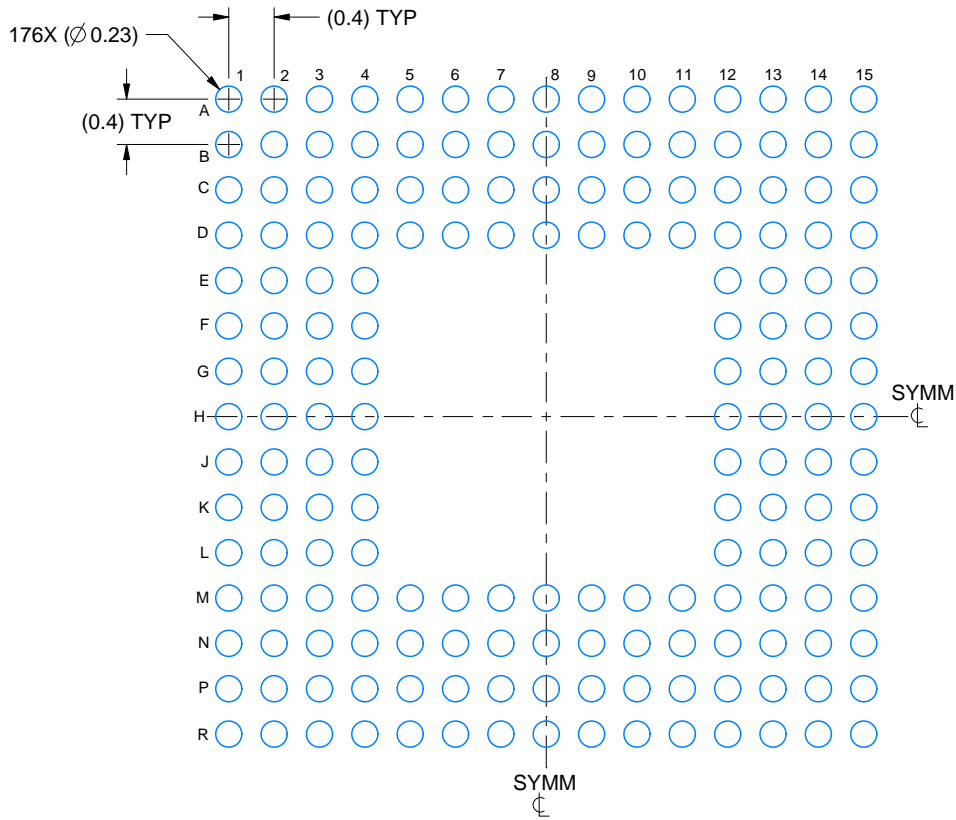
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

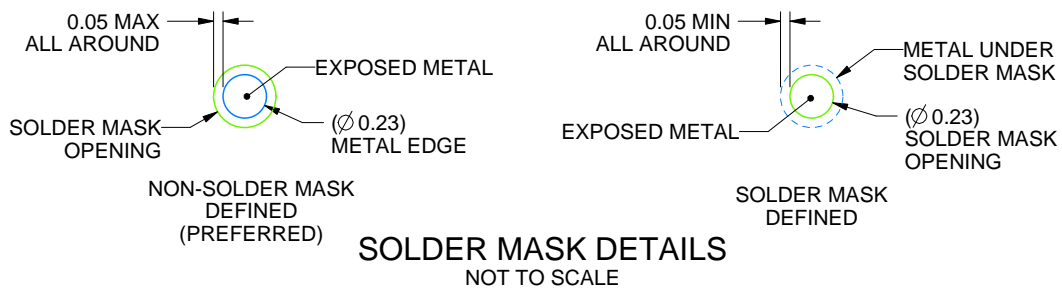
ZVB0176A

NFBGA - 0.95 mm max height

PLASTIC BALL GRID ARRAY



**LAND PATTERN EXAMPLE**  
EXPOSED METAL SHOWN  
SCALE: 15X



4229798/B 11/2023

NOTES: (continued)

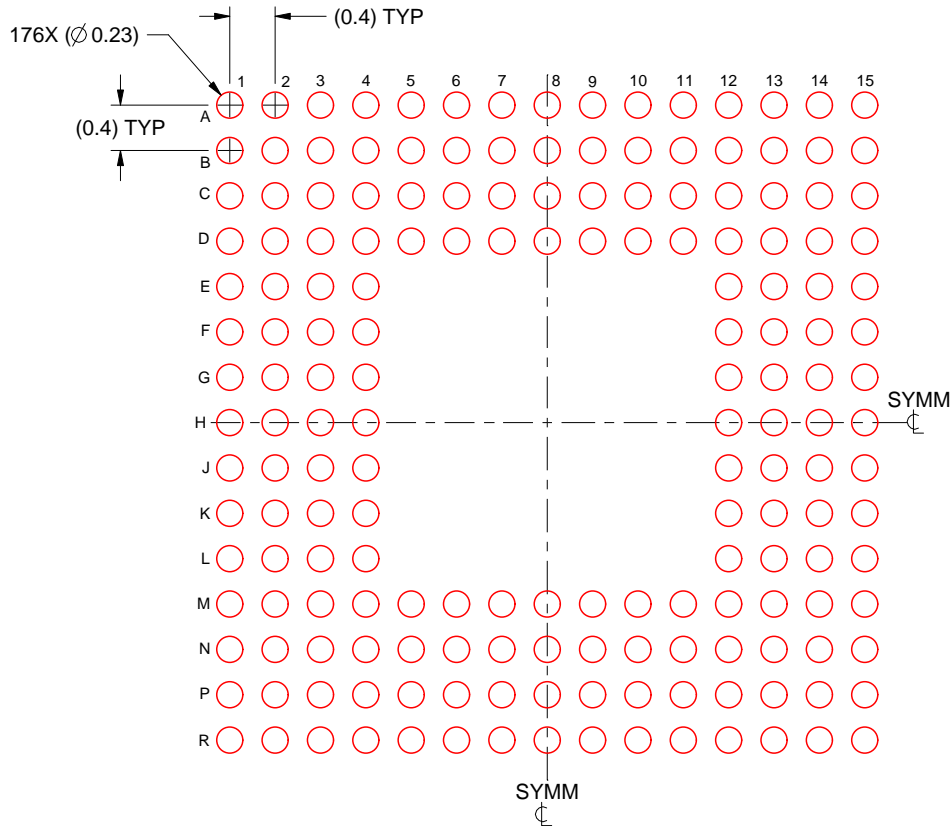
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 ([www.ti.com/lit/spraa99](http://www.ti.com/lit/spraa99)).

# EXAMPLE STENCIL DESIGN

ZVB0176A

NFBGA - 0.95 mm max height

PLASTIC BALL GRID ARRAY



**SOLDER PASTE EXAMPLE**  
BASED ON 0.1 mm THICK STENCIL  
SCALE: 15X

4229798/B 11/2023

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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